Low-ohmic four-pole double-throw analog switch Rev. 2 — 9 November 2011 Proc

**Product data sheet** 

#### **General description** 1.

The NX3DV2567 is a four-pole double-throw analog switch (4PDT) optimized for switching WLAN-SIM supply, data and control signals. It has one digital select input (S) and four switches each with two independent input/outputs (nY0 and nY1) and a common input/output (nZ). Schmitt trigger action at S makes the circuit tolerant to slower input rise and fall times across the entire  $V_{CC}$  range from 1.4 V to 4.3 V.

A low input voltage threshold allows pin S to be driven by lower level logic signals without significant increase in supply current I<sub>CC</sub>. This makes it possible for the NX3DV2567 to switch 4.3 V signals with a 1.8 V digital controller, eliminating the need for logic level translation.

The NX3DV2567 allows signals with amplitude up to V<sub>CC</sub> to be transmitted from nZ to nY0 or nY1; or from nY0 or nY1 to nZ..

#### **Features and benefits** 2.

- Wide supply voltage range from 1.4 V to 4.3 V
- Very low ON resistance for supply path:
  - 0.5 Ω (typical) at V<sub>CC</sub> = 1.8 V
  - 0.45 Ω (typical) at V<sub>CC</sub> = 2.7 V
- Low ON resistance for data path:
  - 7 Ω (typical) at V<sub>CC</sub> = 1.8 V
  - 6 Ω (typical) at V<sub>CC</sub> = 2.7 V
- Low ON capacitance for data path
- Wide –3 db bandwidth > 160 MHz
- Break-before-make switching
- High noise immunity
- ESD protection:
  - HBM JESD22-A114F Class 3A exceeds 4000 V
  - HBM JESD22-A114F Class 3A I/O to GND exceeds 7000 V
  - CDM AEC-Q100-011 revision B exceeds 1000 V
- CMOS low-power consumption
- Latch-up performance exceeds 100 mA per JESD 78B Class II Level A
- 1.8 V control logic at V<sub>CC</sub> = 3.6 V
- Control input accepts voltages above supply voltage
- Very low supply current, even when input is below V<sub>CC</sub>
- High current handling capability (350 mA continuous current under 3.3 V supply for supply path switch)



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■ Specified from -40 °C to +85 °C and from -40 °C to +125 °C

## 3. Applications

- Cell phone, PDA, digital camera, printer and notebook
- LCD monitor, TV and set-top box

### 4. Ordering information

#### Table 1.Ordering information

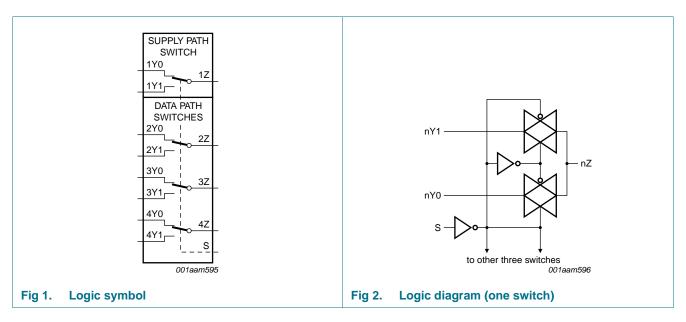
Type number	Package							
	Temperature range Name		Description	Version				
NX3DV2567HR	–40 °C to +125 °C	HXQFN16U	plastic thermal enhanced extremely thin quad flat package; no leads; 16 terminals; UTLP based; body 3 x 3 x 0.5 mm	SOT1039-1				
NX3DV2567GU	–40 °C to +125 °C	XQFN16	plastic, extremely thin quad flat package; no leads; 16 terminals; body 1.80 x 2.60 x 0.50 mm	SOT1161-1				

## 5. Marking

Table 2.   Marking codes	
Type number	Marking code
NX3DV2567HR	D60
NX3DV2567GU	D60

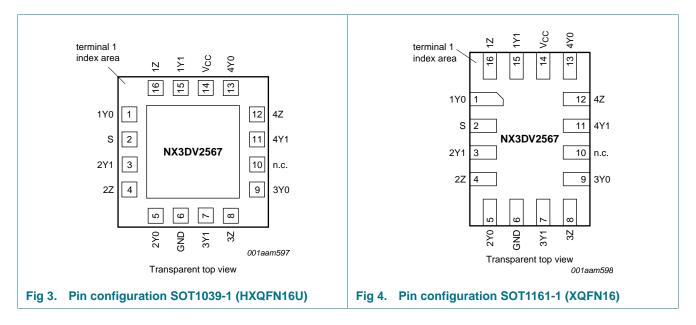
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## 6. Functional diagram



## 7. Pinning information

### 7.1 Pinning



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### 7.2 Pin description

Table 3. Pin description		
Symbol	Pin	Description
1Y0	1	independent input or output (supply switch)
2Y0, 3Y0, 4Y0	5, 9, 13	independent input or output (data switch)
S	2	select input
1Y1	15	independent input or output (supply switch)
2Y1, 3Y1, 4Y1	3, 7, 11	independent input or output (data switch)
1Z	16	common output or input (supply switch)
2Z, 3Z, 4Z	4, 8, 12	common output or input (data switch)
GND	6	ground (0 V)
n.c.	10	not connected
V <sub>CC</sub>	14	supply voltage

### 8. Functional description

Table 4.	Function table <sup>[1]</sup>	
Input S	C	Channel on
L	n	iY0
Н	n	Y1
-		

[1] H = HIGH voltage level; L = LOW voltage level.

### 9. Limiting values

#### Table 5.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+4.6	V
VI	input voltage	select input S	<u>[1]</u>	-0.5	+4.6	V
V <sub>SW</sub>	switch voltage		[2]	-0.5	$V_{CC} + 0.5$	V
l <sub>IK</sub>	input clamping current	V <sub>I</sub> < -0.5 V		-50	-	mA
I <sub>SK</sub>	switch clamping current	$V_{\rm I}$ < -0.5 V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V		-	±50	mA
I <sub>SW</sub>	switch current	supply path switch				
		$V_{SW}$ > -0.5 V or $V_{SW}$ < $V_{CC}$ + 0.5 V; source or sink current		-	±350	mA
		$V_{SW}$ > -0.5 V or $V_{SW}$ < $V_{CC}$ + 0.5 V; pulsed at 1 ms duration, < 10 % duty cycle; peak current		-	±500	mA
		data path switch				
		$V_{SW}$ > -0.5 V or $V_{SW}$ < $V_{CC}$ + 0.5 V; source or sink current		-	±128	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C

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#### Table 5. Limiting values ... continued

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$	[3][4]	250	mW

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

[2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed but may not exceed 4.6 V.

[3] For HXQFN16U package: above 135 °C the value of P<sub>tot</sub> derates linearly with 16.9 mW/K.

[4] For XQFN16 package: above 133 °C the value of Ptot derates linearly with 14.5 mW/K.

### 10. Recommended operating conditions

Table 6.	Recommended operating conditions							
Symbol	Parameter	Conditions	Min	Max	Unit			
V <sub>CC</sub>	supply voltage		1.4	4.3	V			
VI	input voltage	select input S	0	4.3	V			
V <sub>SW</sub>	switch voltage		<u>[1]</u> 0	V <sub>CC</sub>	V			
T <sub>amb</sub>	ambient temperature		-40	+125	°C			
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC}$ = 1.4 V to 4.3 V	[2] _	200	ns/V			

To avoid sinking GND current from terminal nZ when switch current flows in terminal nYn, the voltage drop across the bidirectional [1] switch must not exceed 0.4 V. If the switch current flows into terminal nZ, no GND current will flow from terminal nYn. In this case, there is no limit for the voltage drop across the switch.

[2] Applies to control signal levels.

### 11. Static characteristics

#### Table 7. **Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

Symbol	Parameter	Conditions	Ta	<sub>mb</sub> = 25	°C	T <sub>amb</sub> =	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	
	HIGH-level input voltage	$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	0.9	-	-	0.9	-	-	V
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	0.9	-	-	0.9	-	-	V
		$V_{CC}$ = 2.3 V to 2.7 V	1.1	-	-	1.1	-	-	V
		$V_{CC}$ = 2.7 V to 3.6 V	1.3	-	-	1.3	-	-	V
		$V_{CC}$ = 3.6 V to 4.3 V	1.4	-	-	1.4	-	-	V
V <sub>IL</sub>	LOW-level	$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	-	-	0.3	-	0.3	0.3	V
	input voltage	$V_{CC}$ = 1.65 V to 1.95 V	-	-	0.4	-	0.4	0.3	V
		$V_{CC}$ = 2.3 V to 2.7 V	-	-	0.4	-	0.4	0.4	V
		$V_{CC} = 2.7 V \text{ to } 3.6 V$	-	-	0.5	-	0.5	0.5	V
		$V_{CC}$ = 3.6 V to 4.3 V	-	-	0.6	-	0.6	0.6	V
I	input leakage current	select input S; V <sub>I</sub> = GND to 4.3 V; V <sub>CC</sub> = 1.4 V to 4.3 V	-	-	-	-	±0.5	±1	μΑ

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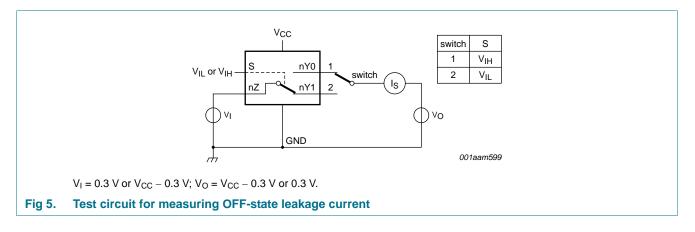
#### Low-ohmic four-pole double-throw analog switch

#### Static characteristics ... continued Table 7.

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

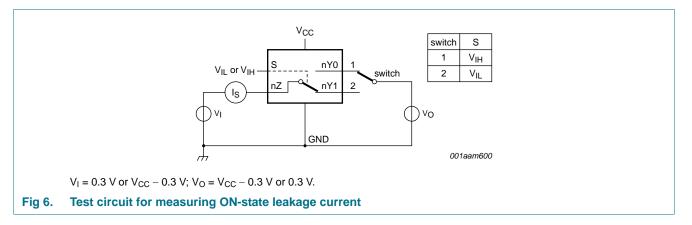
Symbol	Parameter	Conditions	Ta	amb = 25	°C	T <sub>amb</sub> =	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	
I <sub>S(OFF)</sub>	OFF-state leakage	nY0 and nY1 port; see <u>Figure 5</u>	·						
	current	$V_{CC}$ = 1.4 V to 3.6 V	-	-	±5	-	±50	±500	nA
		$V_{CC}$ = 3.6 V to 4.3 V	-	-	±10	-	±50	±500	nA
I <sub>S(ON)</sub>	ON-state leakage current	nZ port; V <sub>CC</sub> = 1.4 V to 3.6 V; see <u>Figure 6</u>							
		$V_{CC}$ = 1.4 V to 3.6 V	-	-	±5	-	±50	±500	nA
		$V_{CC}$ = 3.6 V to 4.3 V	-	-	±10	-	±50	±500	nA
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $V_{SW} = GND$ or $V_{CC}$							
		$V_{CC} = 3.6 V$	-	-	100	-	500	5000	nA
		$V_{CC} = 4.3 V$	-	-	150	-	800	6000	nA
$\Delta I_{CC}$	additional	$V_{SW}$ = GND or $V_{CC}$							
	supply current	$V_{I} = 2.6 \text{ V}; V_{CC} = 4.3 \text{ V}$	-	2.0	4.0	-	7	7	μΑ
		$V_{I} = 2.6 \text{ V}; V_{CC} = 3.6 \text{ V}$	-	0.35	0.7	-	1	1	μA
		$V_{I}$ = 1.8 V; $V_{CC}$ = 4.3 V	-	7.0	10.0	-	15	15	μA
		$V_{I}$ = 1.8 V; $V_{CC}$ = 3.6 V	-	2.5	4.0	-	5	5	μA
		$V_{I}$ = 1.8 V; $V_{CC}$ = 2.5 V	-	50	200	-	300	500	nA
CI	input capacitance		-	1	-	-	-	-	pF
C <sub>S(OFF)</sub>	OFF-state	supply path switch	-	35	-	-	-	-	pF
	capacitance	data path switch	-	3	-	-	-	-	pF
C <sub>S(ON)</sub>	ON-state	supply path switch	-	130	-	-	-	-	pF
	capacitance	data path switch	-	16	-	-	-	-	pF

### 11.1 Test circuits



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### 11.2 ON resistance

#### Table 8. ON resistance

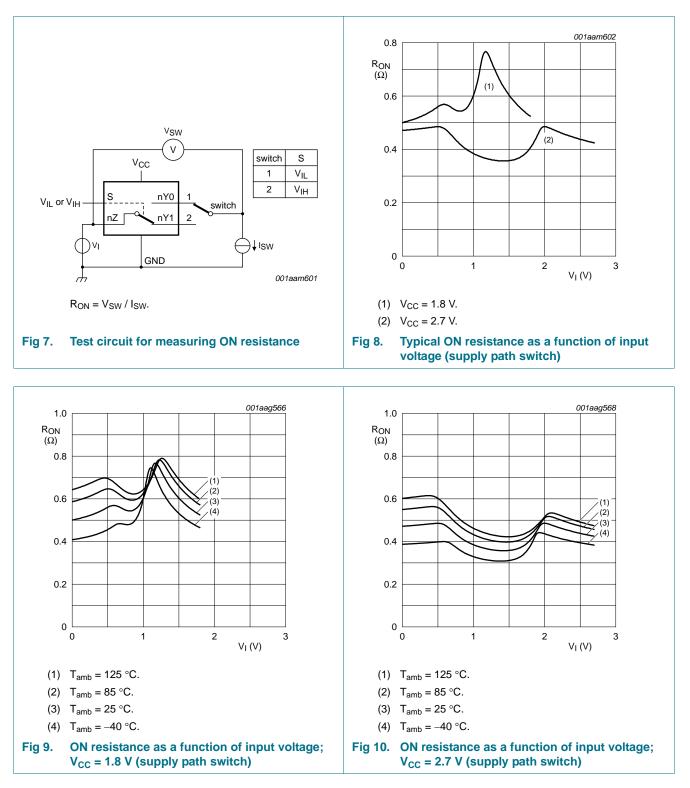
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 8 to Figure 13.

Symbol	Parameter	Conditions		T <sub>amb</sub> = -40 °C to +85 °C			T <sub>amb</sub> = -40 °	Unit	
				in	Typ[1]	Max	Min	Max	
Supply p	oath switch								
R <sub>ON</sub>	ON resistance	$V_I = GND$ to $V_{CC}$ ; $I_{SW} = 100$ mA; see Figure 7							
		$V_{CC} = 1.8 \text{ V}; V_{SW} = 0 \text{ V}, 1.8 \text{ V}$		-	0.5	0.75	-	0.85	Ω
		$V_{CC}$ = 2.7 V; $V_{SW}$ = 0 V, 2.3 V		-	0.45	0.7	-	0.8	Ω
$\Delta R_{ON}$	ON resistance mismatch between channels	$V_I = GND$ to $V_{CC}$ ; $I_{SW} = 100 \text{ mA}$	2]						
		$V_{CC} = 2.7 \text{ V}; V_{SW} = 0 \text{ V}$		-	0.1	-	-	-	Ω
Data pat	h switches								
R <sub>ON</sub>	ON resistance	$V_I = GND \text{ to } V_{CC}; I_{SW} = 20 \text{ mA};$ see Figure 7							
		$V_{CC} = 1.8 \text{ V}; V_{SW} = 0 \text{ V}, 1.8 \text{ V}$		-	7.0	10.0	-	11.0	Ω
		$V_{CC}$ = 2.7 V; $V_{SW}$ = 0 V, 2.3 V		-	6.0	9.5	-	10.5	Ω
$\Delta R_{ON}$	ON resistance	$V_{I} = GND$ to $V_{CC}$ ; $I_{SW} = 20 \text{ mA}$	2]						
	mismatch between channels	$V_{CC} = 2.7 \text{ V}; V_{SW} = 0 \text{ V}$		-	0.2	-	-	-	Ω

[1] Typical values are measured at  $T_{amb}$  = 25 °C.

[2] Measured at identical  $V_{CC}$ , temperature and input voltage.

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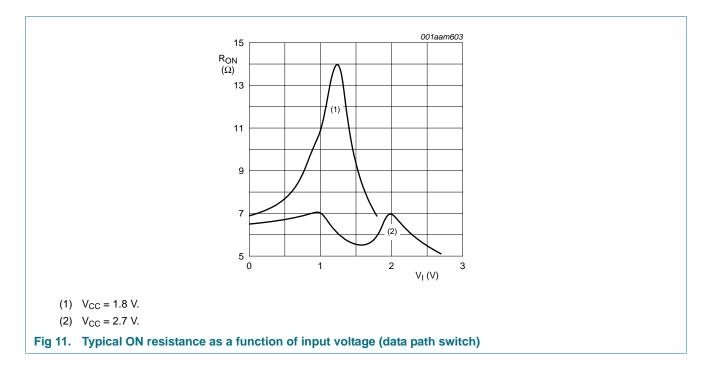


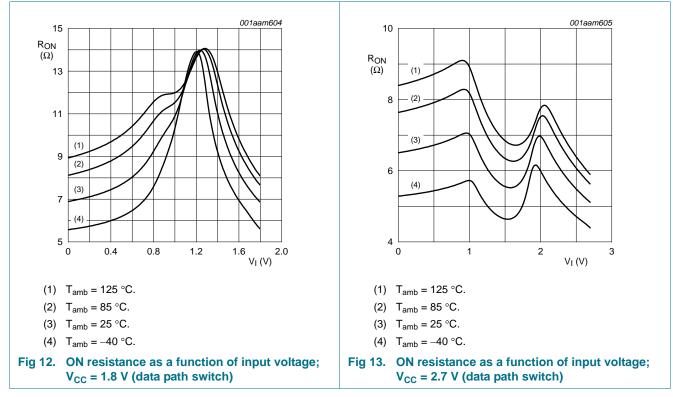
### 11.3 ON resistance test circuit and graphs

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## **12. Dynamic characteristics**

#### Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 16.

Symbol	Parameter	Conditions		25 °C		-40	°C to +12	5 °C	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max (85 °C)	Max (125 °C)	_
Supply p	ath switch								
t <sub>en</sub>	enable time	S to 1Z or 1Y0, 1Y1; see Figure 14							
		$V_{CC}$ = 1.4 V to 1.6 V	-	41	90	-	120	120	ns
		$V_{CC}$ = 1.65 V to 1.95 V	-	30	70	-	80	90	ns
		$V_{CC}$ = 2.3 V to 2.7 V	-	20	45	-	50	55	ns
		$V_{CC}$ = 2.7 V to 3.6 V	-	19	40	-	45	50	ns
		$V_{CC}$ = 3.6 V to 4.3 V	-	19	40	-	45	50	ns
t <sub>dis</sub>	disable time	S to 1Z or 1Y0, 1Y1; see <u>Figure 14</u>							
		$V_{CC}$ = 1.4 V to 1.6 V	-	24	70	-	80	90	ns
		$V_{CC}$ = 1.65 V to 1.95 V	-	15	55	-	60	65	ns
		$V_{CC}$ = 2.3 V to 2.7 V	-	9	25	-	30	35	ns
		$V_{CC}$ = 2.7 V to 3.6 V	-	8	20	-	25	30	ns
		$V_{CC}$ = 3.6 V to 4.3 V	-	8	20	-	25	30	ns
b-m	break-before-make	see Figure 15	2]						
	time	$V_{CC}$ = 1.4 V to 1.6 V	-	20	-	9	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V	-	17	-	7	-	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V	-	13	-	4	-	-	ns
		$V_{CC}$ = 2.7 V to 3.6 V	-	11	-	3	-	-	ns
		$V_{CC}$ = 3.6 V to 4.3 V	-	11	-	2	-	-	ns
Data pat	h switch								
t <sub>en</sub>	enable time	S to nZ or nYn; see <u>Figure 14</u>							
		$V_{CC}$ = 1.4 V to 1.6 V	-	40	90	-	120	120	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	29	70	-	80	90	ns
		$V_{CC}$ = 2.3 V to 2.7 V	-	20	45	-	50	55	ns
		$V_{CC}$ = 2.7 V to 3.6 V	-	19	40	-	45	50	ns
		$V_{CC}$ = 3.6 V to 4.3 V	-	19	40	-	45	50	ns
dis	disable time	S to nZ or nYn; see <u>Figure 14</u>							
		$V_{CC}$ = 1.4 V to 1.6 V	-	21	70	-	80	90	ns
		$V_{CC}$ = 1.65 V to 1.95 V	-	13	55	-	60	65	ns
		$V_{CC}$ = 2.3 V to 2.7 V	-	8	25	-	30	35	ns
		$V_{CC}$ = 2.7 V to 3.6 V	-	7	20	-	25	30	ns
		$V_{CC}$ = 3.6 V to 4.3 V	-	7	20	-	25	30	ns

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Symbol	Parameter	Conditions		25 °C			-40	Unit		
				Min	Typ <mark>[1]</mark>	Мах	Min	Max (85 °C)	Max (125 °C)	
t <sub>b-m</sub> break-before-make	see Figure 15	[2]					1			
	time	$V_{CC}$ = 1.4 V to 1.6 V		-	23	-	9	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		-	19	-	7	-	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V		-	15	-	4	-	-	ns
		$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$		-	13	-	3	-	-	ns
		$V_{CC}$ = 3.6 V to 4.3 V		-	12	-	2	-	-	ns

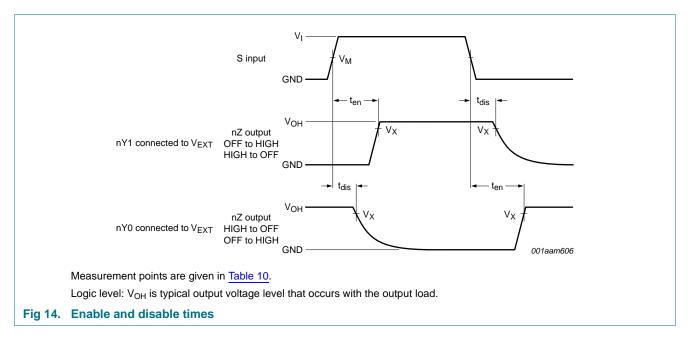
#### Table 9. Dynamic characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 16.

[1] Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.5 V, 1.8 V, 2.5 V, 3.3 V and 4.3 V respectively.

[2] Break-before-make guaranteed by design.

### 12.1 Waveform and test circuits



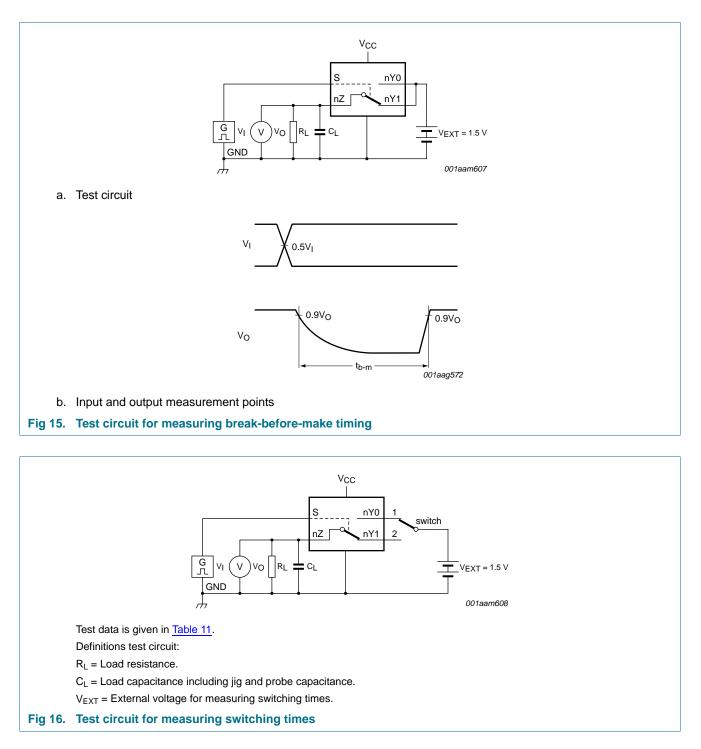
#### Table 10. Measurement points

Supply voltage	Input	Output
V <sub>cc</sub>	V <sub>M</sub>	V <sub>X</sub>
1.4 V to 4.3 V	0.5V <sub>CC</sub>	0.9V <sub>OH</sub>

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#### Table 11. Test data

Supply voltage	Input		oltage Input Load		Load	
V <sub>cc</sub>	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL		
1.4 V to 4.3 V	V <sub>CC</sub>	$\leq$ 2.5 ns	35 pF	50 Ω		

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### 12.2 Additional dynamic characteristics

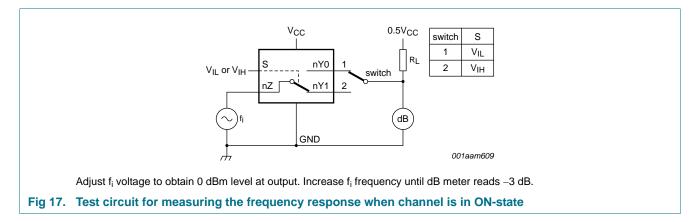
#### Table 12. Additional dynamic characteristics

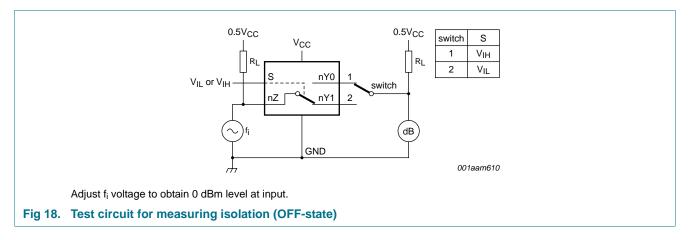
At recommended operating conditions; voltages are referenced to GND (ground = 0 V);  $V_I = GND$  or  $V_{CC}$  (unless otherwise specified);  $t_r = t_f \le 2.5$  ns;  $T_{amb} = 25$  °C.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Data pat	h switch						
f <sub>(-3dB)</sub>	–3 dB frequency response	$R_L = 50 \Omega$ ; see Figure 17	<u>[1]</u>				
		$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$		-	330	-	MHz
$\alpha_{\text{iso}}$	isolation (OFF-state)	$f_i = 10 \text{ MHz}; \text{ R}_L = 50 \Omega; \text{ see } \frac{\text{Figure 18}}{1000 \text{ Hz}}$	<u>[1]</u>				
		$V_{CC} = 2.7 V \text{ to } 3.6 V$		-	-60	-	dB
Xtalk crosstalk	crosstalk	between switches; $f_i = 10 \text{ MHz}$ ; $R_L = 50 \Omega$ ; see <u>Figure 19</u>	<u>[1]</u>				
		$V_{CC} = 2.7 V \text{ to } 3.6 V$		-	-60	-	dB
Q <sub>inj</sub>	charge injection	$      f_i = 1 \text{ MHz; } C_L = 0.1 \text{ nF; } R_L = 1 \text{ M}\Omega;  V_{gen} = 0 \text{ V; } \\ R_{gen} = 0 \Omega; \text{ see } \frac{\text{Figure 20}}{2}      $					
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		-	10	-	рС

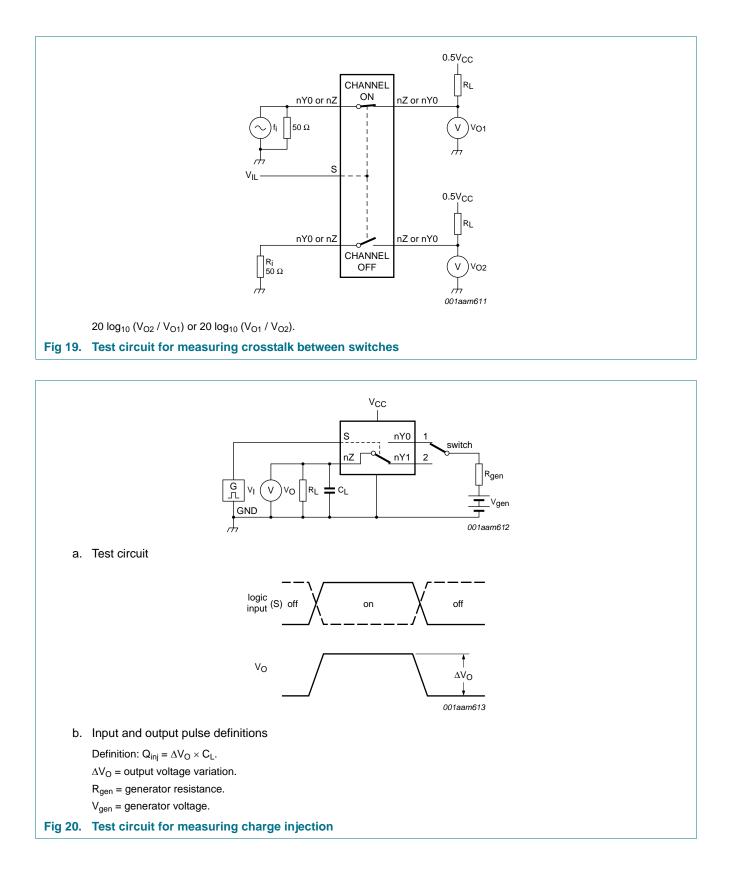
[1]  $f_i$  is biased at 0.5V<sub>CC</sub>.

### 12.3 Test circuits





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### 13. Package outline

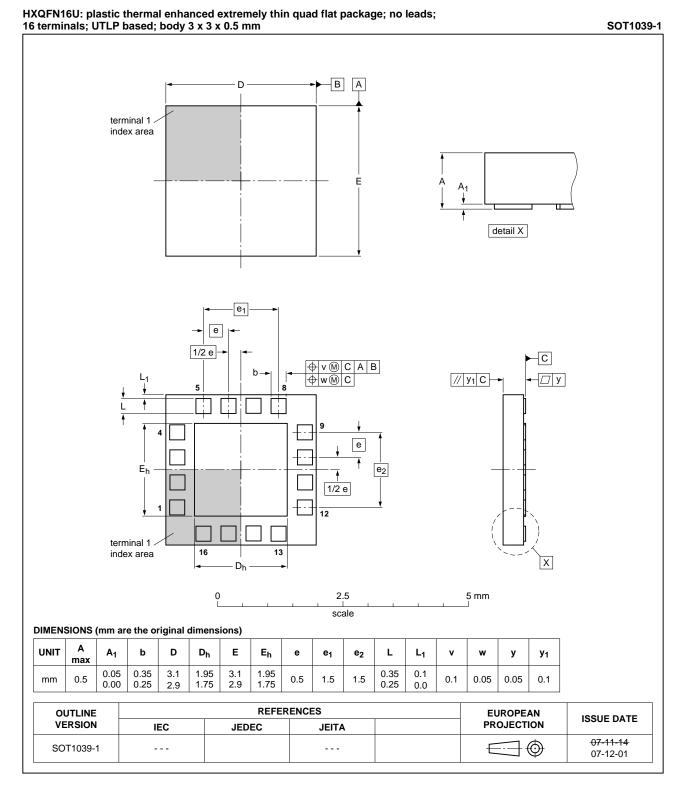
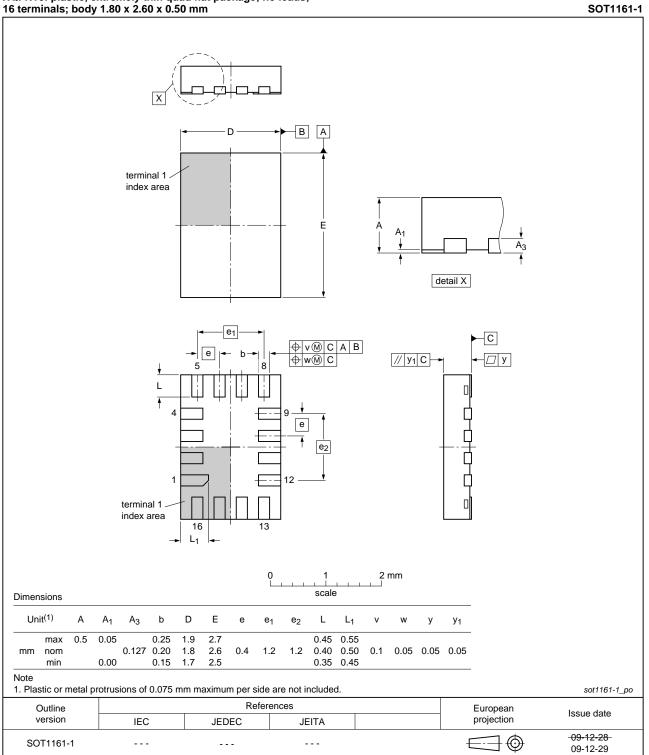


Fig 21. Package outline SOT1039-1 (HXQFN16U)

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Low-ohmic four-pole double-throw analog switch



# XQFN16: plastic, extremely thin quad flat package; no leads; 16 terminals; body 1.80 x 2.60 x 0.50 mm

Fig 22. Package outline SOT1161-1 (XQFN16)

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Low-ohmic four-pole double-throw analog switch

## 14. Abbreviations

Table 13.	Abbreviations
Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
PDA	Personal Digital Assistant
TTL	Transistor-Transistor Logic

## **15. Revision history**

tory			
Release date	Data sheet status	Change notice	Supersedes
20111109	Product data sheet	-	NX3DV2567 v.1
<ul> <li>Legal pages updated.</li> </ul>			
20100928	Product data sheet	-	-
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Low-ohmic four-pole double-throw analog switch

### **16. Legal information**

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Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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